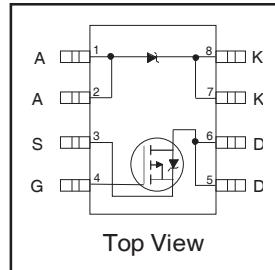


International **IR** Rectifier

IRF7322D1PbF

FETKY™ MOSFET / Schottky Diode

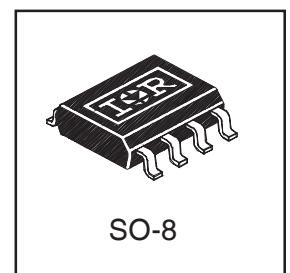
- Co-packaged HEXFET® Power MOSFET and Schottky Diode
- Ideal For Buck Regulator Applications
- P-Channel HEXFET
- Low V_F Schottky Rectifier
- Generation 5 Technology
- SO-8 Footprint
- Lead-Free



| |
|----------------------------|
| $V_{DSS} = -20V$ |
| $R_{DS(on)} = 0.058\Omega$ |
| Schottky $V_f = 0.39V$ |

Description

The **FETKY** family of co-packaged MOSFETs and Schottky diodes offers the designer an innovative, board space saving solution for switching regulator and power management applications. Generation 5 HEXFET Power MOSFETs utilize advanced processing techniques to achieve extremely low on-resistance per silicon area. Combining this technology with International Rectifier's low forward drop Schottky rectifiers results in an extremely efficient device suitable for use in a wide variety of portable electronics applications.



The SO-8 has been modified through a customized leadframe for enhanced thermal characteristics. The SO-8 package is designed for vapor phase, infrared or wave soldering techniques.

Absolute Maximum Ratings ($T_A = 25^\circ C$ unless otherwise noted)

| Parameter | Maximum | Units |
|--------------------------|--|-------|
| $I_D @ T_A = 25^\circ C$ | Continuous Drain Current, $V_{GS} @ -4.5V$ | A |
| $I_D @ T_A = 70^\circ C$ | | |
| I_{DM} | -43 | |
| $P_D @ T_A = 25^\circ C$ | Power Dissipation | W |
| $P_D @ T_A = 70^\circ C$ | | |
| V_{GS} | 16 | mW/°C |
| V_{GS} | ± 12 | V |
| dv/dt | Peak Diode Recovery dv/dt ② | V/ns |
| T_J, T_{STG} | Junction and Storage Temperature Range | °C |

Thermal Resistance Ratings

| Parameter | Maximum | Units |
|-----------|---------|-------|
| $R_{θJA}$ | 62.5 | °C/W |

Notes:

- ① Repetitive rating; pulse width limited by maximum junction temperature (see figure 9)
- ② $I_{SD} \leq -2.9A$, $di/dt \leq -77A/\mu s$, $V_{DD} \leq V_{(BR)DSS}$, $T_J \leq 150^\circ C$
- ③ Pulse width $\leq 300\mu s$; duty cycle $\leq 2\%$
- ④ Surface mounted on FR-4 board, $t \leq 10sec$.

MOSFET Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

| Parameter | | Min. | Typ. | Max. | Units | Conditions |
|-----------------------------|--------------------------------------|-------|-------|-------|---------------|--|
| $V_{(\text{BR})\text{DSS}}$ | Drain-to-Source Breakdown Voltage | -20 | — | — | V | $V_{\text{GS}} = 0\text{V}$, $I_D = -250\mu\text{A}$ |
| $R_{\text{DS}(\text{on})}$ | Static Drain-to-Source On-Resistance | — | 0.049 | 0.062 | Ω | $V_{\text{GS}} = -4.5\text{V}$, $I_D = -2.9\text{A}$ ③ |
| | | — | 0.082 | 0.098 | | $V_{\text{GS}} = -2.7\text{V}$, $I_D = -1.5\text{A}$ ③ |
| $V_{\text{GS}(\text{th})}$ | Gate Threshold Voltage | -0.70 | — | — | V | $V_{\text{DS}} = V_{\text{GS}}$, $I_D = -250\mu\text{A}$ |
| g_f | Forward Transconductance | — | 5.9 | — | S | $V_{\text{DS}} = -10\text{V}$, $I_D = -1.5\text{A}$ |
| I_{DSS} | Drain-to-Source Leakage Current | — | — | -1.0 | μA | $V_{\text{DS}} = -16\text{V}$, $V_{\text{GS}} = 0\text{V}$ |
| | | — | — | -25 | | $V_{\text{DS}} = -16\text{V}$, $V_{\text{GS}} = 0\text{V}$, $T_J = 55^\circ\text{C}$ |
| I_{GSS} | Gate-to-Source Forward Leakage | — | — | 100 | nA | $V_{\text{GS}} = -12.0\text{V}$ |
| | Gate-to-Source Reverse Leakage | — | — | -100 | | $V_{\text{GS}} = 12.0\text{V}$ |
| Q_g | Total Gate Charge | — | 19 | 29 | nC | $I_D = -2.9\text{A}$ |
| Q_{gs} | Gate-to-Source Charge | — | 4.0 | 6.1 | | $V_{\text{DS}} = -16\text{V}$ |
| Q_{gd} | Gate-to-Drain ("Miller"') Charge | — | 7.7 | 12 | | $V_{\text{GS}} = -4.5\text{V}$ (see figure 6) ③ |
| $t_{\text{d}(\text{on})}$ | Turn-On Delay Time | — | 15 | 22 | ns | $V_{\text{DD}} = -10\text{V}$ |
| t_r | Rise Time | — | 40 | 60 | | $I_D = -2.9\text{A}$ |
| $t_{\text{d}(\text{off})}$ | Turn-Off Delay Time | — | 42 | 63 | | $R_G = 6.0\Omega$ |
| t_f | Fall Time | — | 49 | 73 | | $R_D = 3.4\Omega$ ③ |
| C_{iss} | Input Capacitance | — | 780 | — | pF | $V_{\text{GS}} = 0\text{V}$ |
| C_{oss} | Output Capacitance | — | 470 | — | | $V_{\text{DS}} = -15\text{V}$ |
| C_{rss} | Reverse Transfer Capacitance | — | 240 | — | | $f = 1.0\text{MHz}$ (see figure 5) |

MOSFET Source-Drain Ratings and Characteristics

| Parameter | | Min. | Typ. | Max. | Units | Conditions |
|-----------------|--|------|------|------|-------|---|
| I_S | Continuous Source Current (Body Diode) | — | — | -2.5 | A | |
| I_{SM} | Pulsed Source Current (Body Diode) | — | — | -21 | | |
| V_{SD} | Body Diode Forward Voltage | — | — | -1.2 | V | $T_J = 25^\circ\text{C}$, $I_S = -2.9\text{A}$, $V_{\text{GS}} = 0\text{V}$ |
| t_{rr} | Reverse Recovery Time (Body Diode) | — | 47 | 71 | ns | $T_J = 25^\circ\text{C}$, $I_F = -2.9\text{A}$ |
| Q_{rr} | Reverse Recovery Charge | — | 49 | 73 | nC | $dI/dt = 100\text{A}/\mu\text{s}$ ③ |

Schottky Diode Maximum Ratings

| | Parameter | Max. | Units | Conditions | |
|--------------------|--|------|-------|--|--|
| $I_{\text{F(av)}}$ | Max. Average Forward Current | 2.7 | A | 50% Duty Cycle. Rectangular Wave, $T_A = 25^\circ\text{C}$ | |
| | | 2 | | See Fig. 14 $T_A = 70^\circ\text{C}$ | |
| I_{SM} | Max. peak one cycle Non-repetitive Surge current | 120 | A | 5μs sine or 3μs Rect. pulse | Following any rated load condition & with V_{RRM} applied |
| | | 11 | | 10ms sine or 6ms Rect. pulse | |

Schottky Diode Electrical Specifications

| | Parameter | Max. | Units | Conditions | |
|-----------------|------------------------------|------|-------|---|---------------------------|
| V_{FM} | Max. Forward voltage drop | 0.50 | V | $I_F = 1.0\text{A}$, $T_J = 25^\circ\text{C}$ | |
| | | 0.62 | | $I_F = 2.0\text{A}$, $T_J = 25^\circ\text{C}$ | |
| | | 0.39 | | $I_F = 1.0\text{A}$, $T_J = 125^\circ\text{C}$ | |
| | | 0.57 | | $I_F = 2.0\text{A}$, $T_J = 125^\circ\text{C}$. | |
| I_{RM} | Max. Reverse Leakage current | 0.02 | mA | $V_R = 20\text{V}$ | $T_J = 25^\circ\text{C}$ |
| | | 8 | | | $T_J = 125^\circ\text{C}$ |
| C_t | Max. Junction Capacitance | 92 | pF | $V_R = 5\text{Vdc}$ (100kHz to 1 MHz) 25°C | |
| dv/dt | Max. Voltage Rate of Change | 3600 | V/μs | Rated V_R | |

Power Mosfet Characteristics

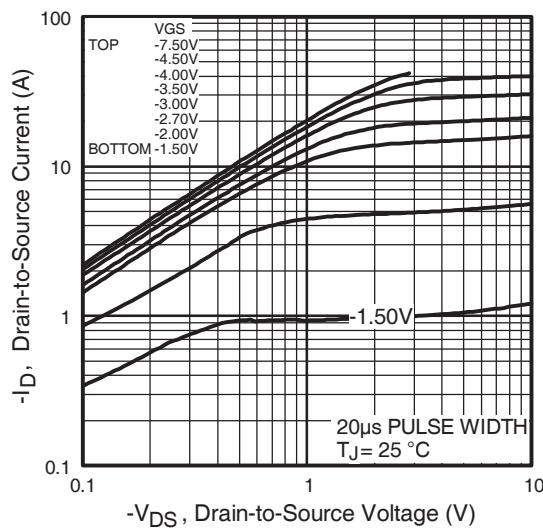


Fig 1. Typical Output Characteristics

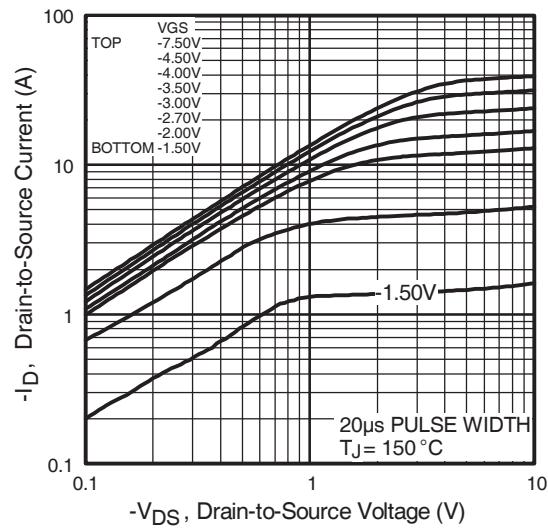


Fig 2. Typical Output Characteristics

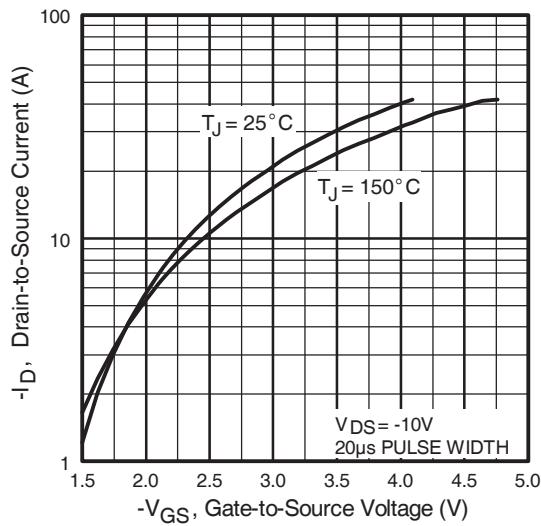


Fig 3. Typical Transfer Characteristics

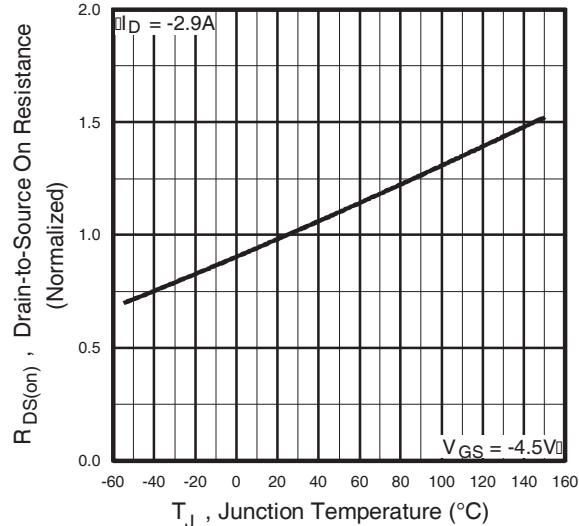


Fig 4. Normalized On-Resistance Vs. Temperature

IRF7322D1PbF

Power Mosfet Characteristics

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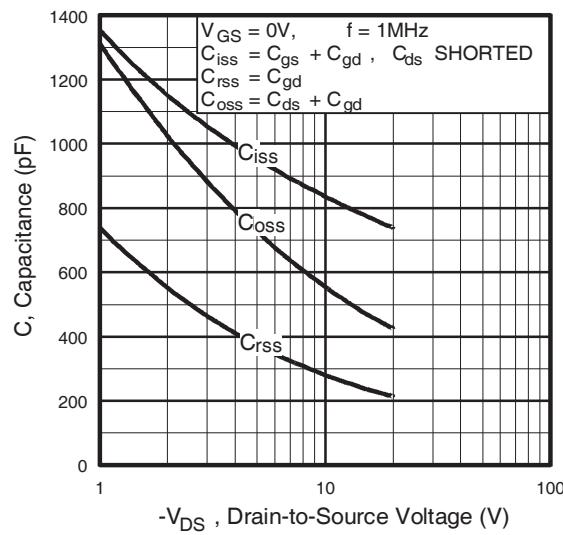


Fig 5. Typical Capacitance Vs.
Drain-to-Source Voltage

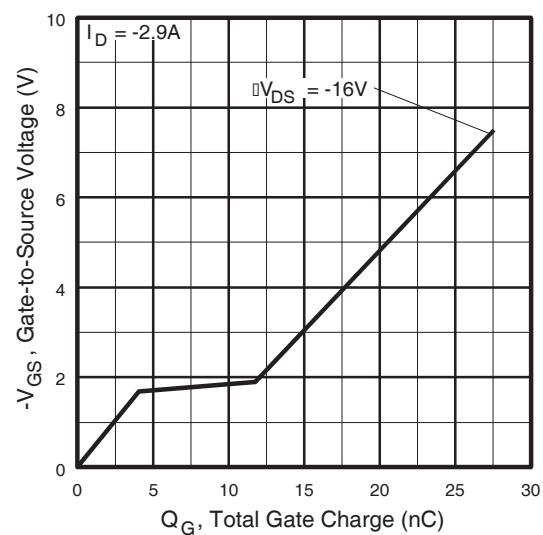


Fig 6. Typical Gate Charge Vs.
Gate-to-Source Voltage

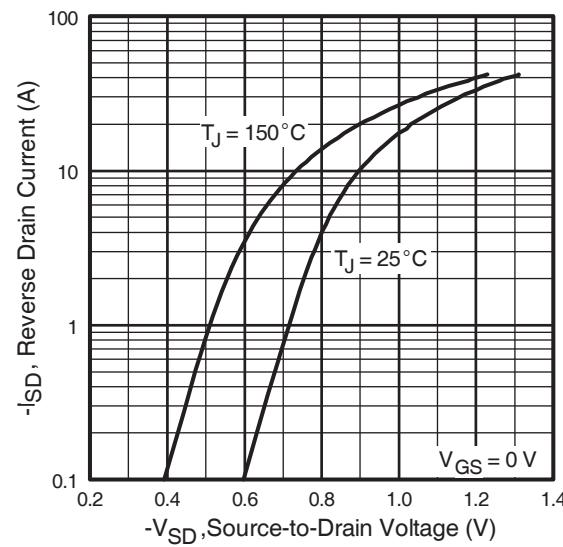


Fig 7. Typical Source-Drain Diode
Forward Voltage

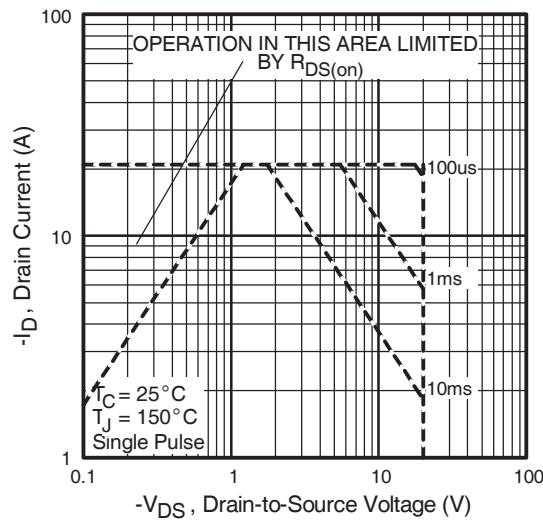


Fig 8. Maximum Safe Operating Area

Power Mosfet Characteristics

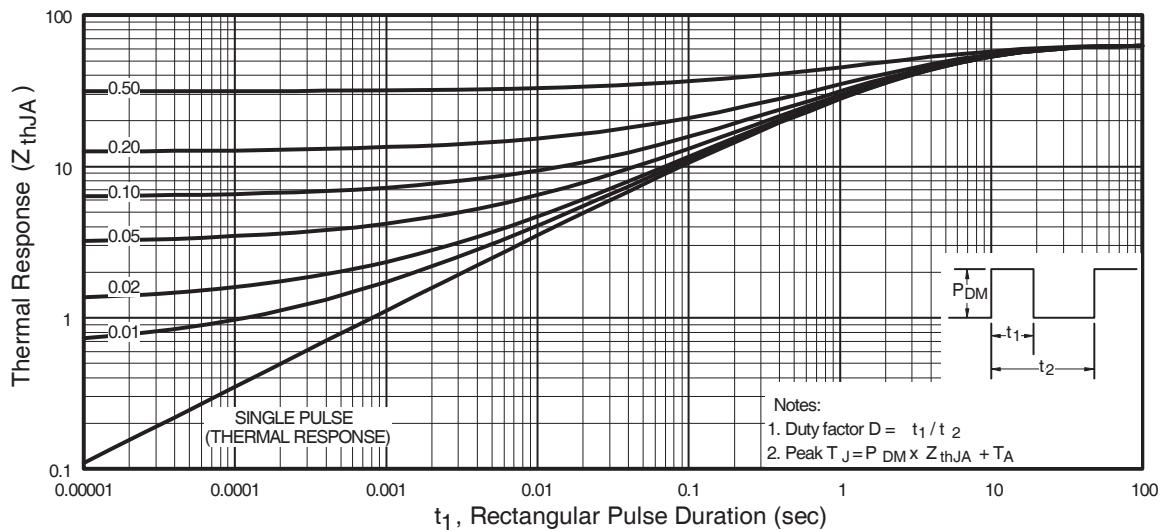


Fig 9. Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

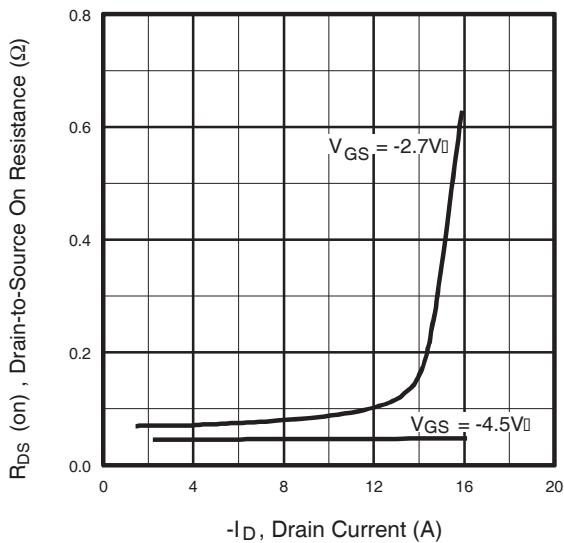


Fig 10. Typical On-Resistance Vs. Drain Current

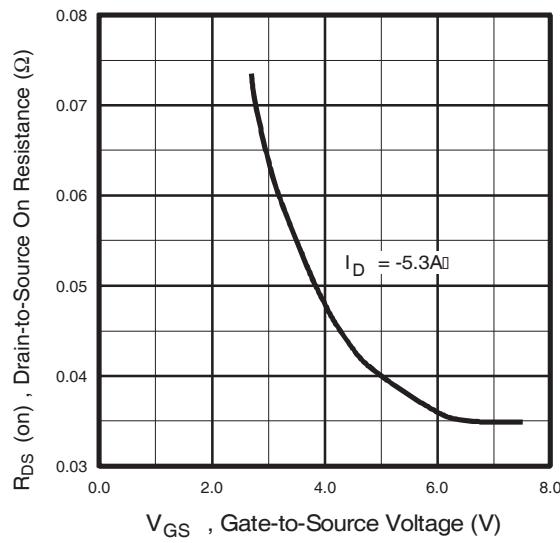


Fig 11. Typical On-Resistance Vs. Gate Voltage

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Schottky Diode Characteristics

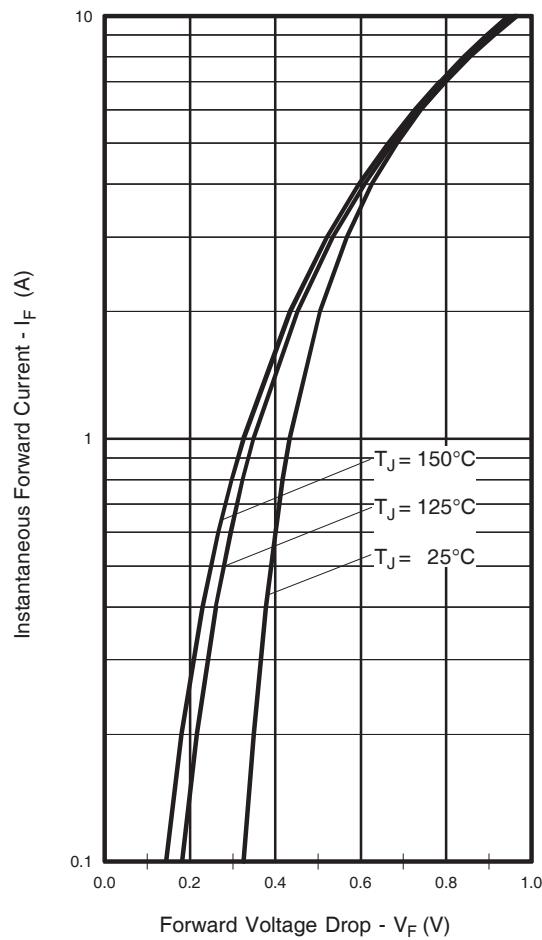


Fig. 12 - Typical Forward Voltage Drop Characteristics

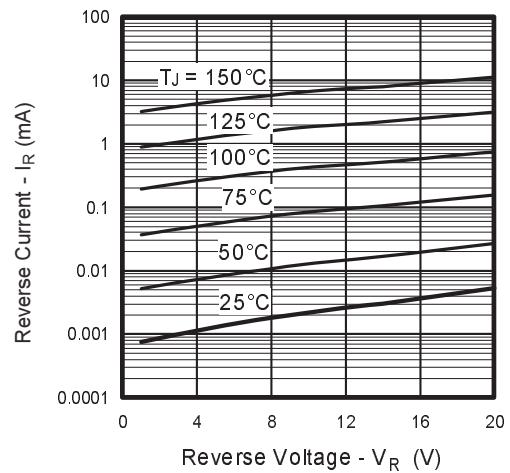


Fig. 13 - Typical Values of Reverse Current Vs. Reverse Voltage

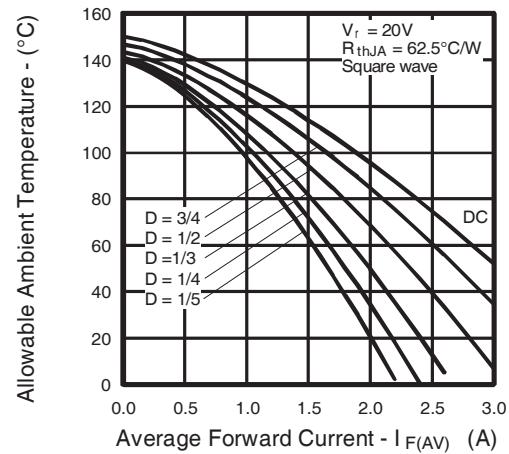
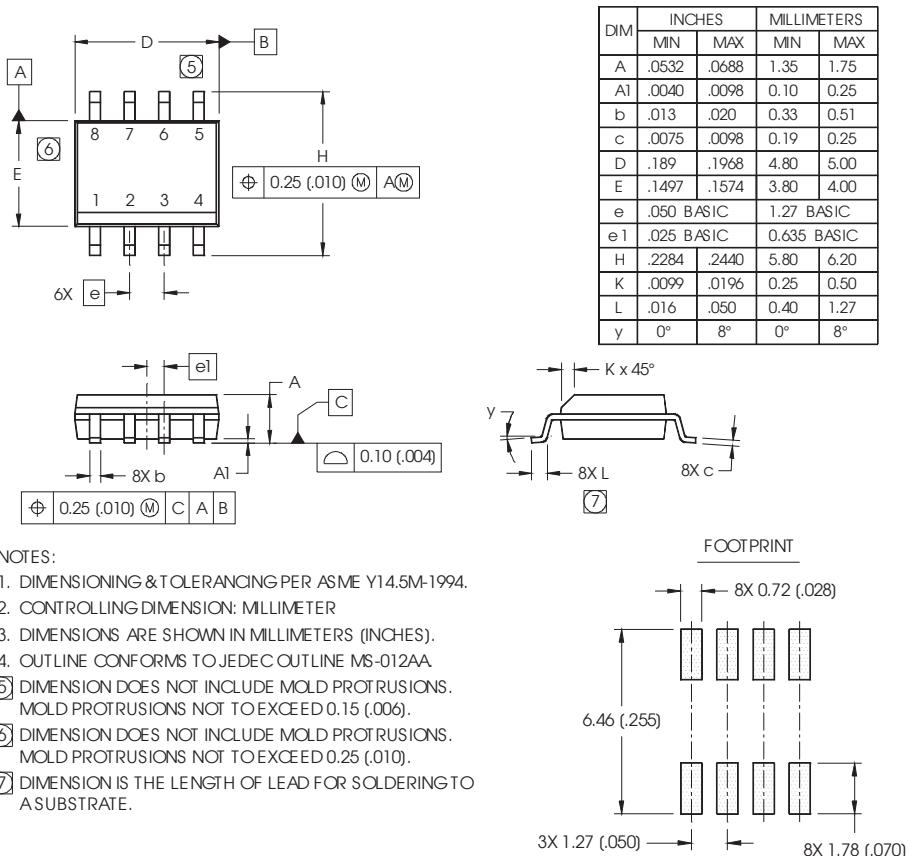


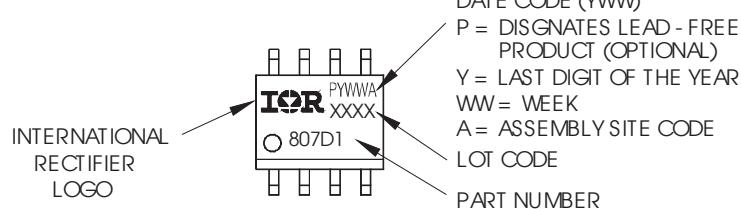
Fig.14 - Maximum Allowable Ambient Temp. Vs. Forward Current

SO-8 (Fetky) Package Outline



SO-8 (Fetky) Part Marking Information

EXAMPLE: THIS IS AN IRF7807D1 (FETKY)

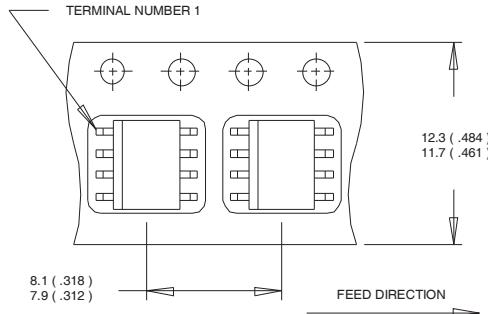


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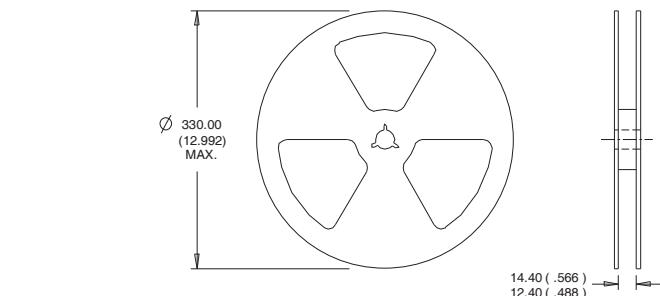
SO-8 Tape and Reel

Dimensions are shown in millimeters (inches)



NOTES:

1. CONTROLLING DIMENSION : MILLIMETER.
2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS(INCHES).
3. OUTLINE CONFORMS TO EIA-481 & EIA-541.



NOTES :

1. CONTROLLING DIMENSION : MILLIMETER.
2. OUTLINE CONFORMS TO EIA-481 & EIA-541.

Data and specifications subject to change without notice.
This product has been designed and qualified for the Consumer market.
Qualifications Standards can be found on IR's Web site.

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